



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re: Application of:

Ping-Kun Wu

Group Art Unit: 2814

Serial No.: 10/723,509

Examiner: Chambliss, Alonzo

Filed: Nov. 25, 2003

In Response to Office Action
Dated: March 2, 2005

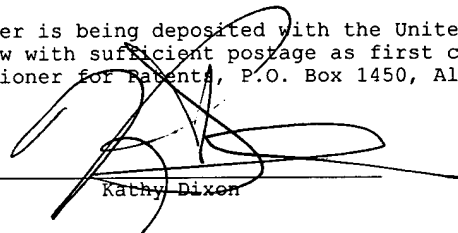
For: Method For Forming A Multi-Layer Seed Layer For
Improved Cu ECP

Attorney Docket No.: 67,200-1190

Certificate of Mailing

I hereby certify that this paper is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: Apr. 7, 2005


Kathy Dixon

RESPONSE TO OFFICE ACTION

Commissioner for Patents
Alexandria, VA 22313-1450

Dear Sir:

In response to an Office Action mailed March 2, 2005 of a restriction requirement imposed by the Examiner, the Applicants hereby elect with traverse the prosecution of Group I, method claims 1-29.

Attached herewith is a Petition for Extension of Time, together with a Credit Card Payment Form, to extend the reply time period to May 2, 2005.